## **AMENDMENTS TO THE CLAIMS:**

This listing of claims will replace all prior versions and listings of claims in the application:

## **Listing of Claims:**

1. (Currently amended) An apparatus for manufacturing ultra-fine particles using corona discharge, comprising:

a reaction gas supplying means for supplying reaction gas;

at least one nozzle connected to the reaction gas supplying means for supplying reaction gas, configured for injecting the reaction gas flowing therein, and configured for producing a large number of ultra-fine particles by corona discharge of the injected reaction gas;

a power supplying means connected to the nozzle for applying a voltage to the at least one nozzle and configured for causing the corona discharge thereto at the at least one nozzle; and

a collecting means spaced from the nozzle and for collecting the ultra-fine particles produced by the corona discharge of the nozzle.

- 2. (Currently amended) The apparatus as claimed in claim 1, further comprising a duct enclosing the <u>at least one</u> nozzle to cause <u>and configured for forming</u> a passage to be formed between the <u>at least one</u> nozzle and the duct, and <del>a sheath gas supplying</del> means for supplying sheath gas to the passage of the duct in order to form a gas curtain that leads flow of the ultrafine particles between the <u>at least one</u> nozzle and the collecting means for collecting.
- 3. (Currently amended) The apparatus as claimed in claim 2, further comprising a first variable resistor <u>configured for</u> dropping a high voltage applied from the <del>power supplying</del> means

<u>for applying a voltage</u> to a low voltage and <u>configured for</u> applying the <u>a</u> low voltage to the duct, and a second variable resistor connected to the first variable resistor and grounded.

- 4. (Currently amended) The apparatus as claimed in claim 2, wherein a tip of the <u>at least</u> <u>one</u> nozzle extrudes out of the duct, the apparatus further comprising <del>a delivering</del> means for delivering the <u>eollecting</u> means <u>for collecting</u>.
- 5. (Currently amended) An apparatus for manufacturing ultra-fine particles using corona discharge, comprising:

a first reaction gas supplying means for supplying a first reaction gas;

at least [[a]] one first nozzle connected to the first reaction gas supplying means for supplying a first reaction gas, configured for injecting the first reaction gas flowing therein, and configured for producing a large number of first ultra-fine particles by corona discharge of the injected first reaction gas;

a first power supplying means connected to the first nozzle for applying a first voltage to the at least one first nozzle and configured for causing corona discharge thereto at the at least one first nozzle;

 $\underline{a}$  second reaction gas supplying means for supplying  $\underline{a}$  second reaction gas different from the first reaction gas;

at least [[a]] one second nozzle faced to and spaced from the at least one first nozzle, connected to the second reaction gas supplying means for supplying a second reaction gas, configured for injecting the second reaction gas flowing therein, and configured for producing a large-number of second ultra-fine particles by corona discharge of the injected second reaction gas; and

a second power supplying means connected to the second nozzle for applying a second voltage at the at least one second nozzle and configured for causing corona discharge thereto at

the at least one second nozzle in order for the first ultra-fine particles and the second ultra-fine particles to adhere to each other between the <u>at least one</u> first nozzle and the <u>at least one</u> second nozzle.

6. (Currently amended) An apparatus for manufacturing ultra-fine particles using corona discharge, comprising:

a first reaction gas supplying means for supplying a first reaction gas;

at least one nozzle connected to the first reaction gas supplying means for supplying a first reaction gas, configured for injecting the first reaction gas flowing therein, and configured for producing a large number of first ultra-fine particles by corona discharge of the injected first reaction gas;

a power supplying means connected to the nozzle for applying a high voltage to the at least one nozzle and configured for causing corona discharge thereto at the at least one nozzle;

a duct enclosing the <u>at least one</u> nozzle to cause <u>and configured for forming</u> a passage to be formed between the <u>at least one</u> nozzle and the duct;

a second reaction gas supplying means for supplying the passage of the duct with  $\underline{a}$  second reaction gas different from the first reaction gas;

a heating means for heating installed on an outer surface of the duct and configured for providing heat energy to the second reaction gas in order to coat the first ultra-fine particles with a large number of second ultra-fine particles, when the second ultra-fine particles being are obtained by thermochemical reaction of the second reaction gas; and

a collecting means for collecting spaced from the duct and configured for collecting the first ultra-fine particles coated with the second ultra-fine particles.

7. (Currently amended) The apparatus as claimed in claim 6, wherein the <u>at least one</u> nozzle is entirely accommodated in the passage of the duct.

8. (Currently amended) An apparatus for manufacturing ultra-fine particles using corona discharge, comprising:

a first reaction gas supplying means for supplying a first reaction gas;

at least [[a]] <u>one</u> first nozzle connected to the <u>first reaction gas supplying</u> means <u>for supplying a first reaction gas</u>, <u>configured for</u> injecting the first reaction gas flowing therein, and <u>configured for</u> producing a <u>large</u> number of first ultra-fine particles by corona discharge of <u>the</u> injected first reaction gas;

a first power supplying means connected to the first nozzle for applying a first high voltage to the at least one first nozzle and configured for causing corona discharge thereto at the at least one first nozzle;

a first duct enclosing the <u>at least one first</u> nozzle <del>to cause</del> <u>and configured for forming</u> a passage <del>to be formed</del> between the <u>at least one</u> first nozzle and the first duct;

a second reaction gas supplying means for supplying the passage of the first duct with  $\underline{a}$  second reaction gas different from the first reaction gas;

at least [[a]] <u>one</u> second nozzle installed at a distal end of the first duct, <u>configured for</u> injecting the first ultra-fine particles and the second reaction gas flowing therein, <u>configured for</u> producing a <u>large</u> number of second ultra-fine particles by corona discharge of <u>the</u> injected second reaction gas, and <u>configured for</u> coating the first ultra-fine particles with the second ultra-fine particles;

a second power supplying means connected to the second nozzle for applying a second high voltage to the at least one second nozzle and configured for causing corona discharge thereto at the at least one second nozzle; and

a collecting means for collecting spaced from the at least one second nozzle and configured for collecting the first ultra-fine particles coated with the second ultra-fine particles.

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9. (Currently amended) The apparatus as claimed in claim 8, further comprising a second duct enclosing the first duct and the <u>at least one</u> second nozzle to cause configured for forming a passage to be formed between the first duct and the second duct and between the <u>at least one</u> second nozzle and the second duct, and <u>a sheath gas supplying</u> means for supplying sheath gas to the passage of the second duct to form configured for forming a gas curtain that leads flow of the first ultra-fine particles coated with the second ultra-fine particles between the <u>at least one</u> second nozzle and the collecting means for collecting.

- 10. (Currently amended) The apparatus as claimed in claim 9, further comprising a first variable resistor configured for dropping the first high voltage applied from the first power supplying means for applying a first high voltage to a first low voltage and configured for applying the a first low voltage to the first duct, a second variable resistor connected to the first variable resistor and grounded, a third variable resistor configured for dropping the second high voltage applied from the second power supplying means for applying a second high voltage to a second low voltage and configured for applying the a second low voltage to the second duct, and a fourth variable resistor connected to the third variable resistor and grounded.
- 11. (Currently amended) The apparatus as claimed in claim 9, wherein a tip of the <u>at</u> <u>least one</u> second nozzle extrudes out of the second duct, the apparatus further comprising a <u>delivering</u> means for delivering the <u>collecting</u> means <u>for collecting</u>.
- 12. (Currently amended) A method for manufacturing ultra-fine particles using corona discharge, comprising steps of:

generating corona discharge by allowing a power supplying means to apply applying a high voltage to a nozzle;

supplying reaction gas to the nozzle by a reaction gas supplying means;

producing a <del>large</del> number of ultra-fine particles by injecting the reaction gas into a corona discharge region of the nozzle; and

collecting the ultra-fine particles by a collecting means, the ultra-fine particles passing through the corona discharge region of the nozzle.

- 13. (Currently amended) The method as claimed in claim 12, wherein the high voltage is applied in the form of a pulse.
- 14. (Currently amended) The method as claimed in claim 12, further comprising the step of forming a gas curtain of sheath gas in order to lead flow of the ultra-fine particles between the nozzle and the <u>location of collecting means</u>.
- 15. (Currently amended) The method as claimed in claim 12, further comprising the steps of supplying other a second reaction gas different from the reaction gas to the surroundings of the ultra-fine particles flowing from the nozzle to the location of collecting means, producing a large number of other second ultrafine particles by allowing the other second reaction gas to react thermochemically by providing the other second reaction gas with heat energy, and coating the ultra-fine particles with the other second ultra-fine particles.
- 16. (Currently amended) A method for manufacturing ultra-fine particles using corona discharge, comprising steps of:

generating corona discharge by allowing a first power supplying means to apply applying a first high voltage to a first nozzle;

generating corona discharge by allowing a second power supplying means to apply applying a second high voltage to a second nozzle positioned downstream of the first nozzle;

injecting <u>a</u> first reaction gas into a corona discharge region of the first nozzle <del>by allowing</del> a first reaction gas supplying means to supply the first reaction gas to the first nozzle;

producing a large number of first ultra-fine particles by injecting the first reaction gas into a corona discharge region of the first nozzle;

mixing the first ultra-fine particles and second reaction gas and supplying them to the second nozzle by a second reaction gas supplying means;

injecting <u>a</u> mixed gas of the ultra-fine particles and the second reaction gas into a corona discharge region of the second nozzle and coating the first ultra-fine particles with a <del>large</del> number of second ultra-fine particles produced from the second reaction gas; and

collecting the first ultra-fine particles coated with the second ultra-fine particles by a collecting means.

- 17. (Currently amended) The method as claimed in claim 16, further comprising the step of forming a gas curtain of sheath gas in order to lead flow of the ultra-fine particles between the second nozzle and the <u>location of collecting means</u>.
- 18. (Currently amended) The method as claimed in claim 16, wherein the first and second high voltages are applied in the form of a pulse.